

# Intel Platform Memory Operations

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### DDR4 2133 Memory Down Validation Results

Listed below are the results from a small sample of DDR4 2133 DRAM tested on Intel reference mobile platforms based on 6<sup>th</sup> Gen Intel® Core™ i7 processors (codename Skylake). We are providing this information as a guide to component performance with Intel® reference platforms. This testing is not intended to replace the normal OEM component qualification process. For results on specific Intel® motherboards or OEM production motherboards, please refer to the OEM's list of qualified memory suppliers.

#### DRAM DDR4-2133 (Memory Down)

Supplier	Part Number	Packaged Density	Density Die	Package	Width	Die Revision	DRAM DateCode	Note
Micron	MT40A512M8HX-093E:A	4Gb	4Gb	SDP	x8	A	1422	2
Micron	MT40A512M8RH-083E:B	4Gb	4Gb	SDP	x8	B	1618	
Micron	MT40A256M16GE-083E:B	4Gb	4Gb	SDP	x16	B	1602	
Micron	MT40A256M16GE-075E:B	4Gb	4Gb	SDP	x16	B	1618	
Micron	MT40A1G8PM-083E:A	8Gb	8Gb	SDP	x8	A	1618	
Micron	MT40A1G8WE-083E:B	8Gb	8Gb	SDP	x8	B	1608	3
Micron	MT40A512M16HA-083E:A	8Gb	8Gb	SDP	x16	A	1618	

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Micron	MT40A512M16JY-083E:B	8Gb	8Gb	SDP	x16	B	1602	3
Micron	MT40A1G16HBA-083E:A	16Gb	8Gb	DDP	x16	A	1618	
SK hynix	H5AN4G8NAFR-TFC	4Gb	4Gb	SDP	x8	A	1618	1
SK hynix	H5AN8G8NMFR-TFC	8Gb	8Gb	SDP	x8	M	1618	1
SK hynix	H5AN8G6NAFR-TFC	8Gb	8Gb	SDP	x16	A	1622	
SK hynix	H5AN8G8NAFR-TFC	8Gb	8Gb	SDP	x8	A	1605	
SK hynix	H5AN4G6NAFR-UHC	4Gb	4Gb	SDP	x16	A	1618	
SK hynix	H5AN8G8NAFR-UHC	8Gb	8Gb	SDP	x8	A	1622	
SK hynix	H5AN8G6NAFR-UHC	8Gb	8Gb	SDP	x16	A	1622	
SK hynix	H5AN8G8NMFR-UHC	8Gb	8Gb	SDP	x8	M	1618	
Samsung	K4A4G085WB-BCPB	4Gb	4Gb	SDP	x8	D	1618	
Samsung	K4A4G085WE-BCRC	4Gb	4Gb	SDP	x8	E	1622	
Samsung	K4A4G165WE-BCRC	4Gb	4Gb	SDP	x16	E	1622	
Samsung	K4A4G165WE-BCPB	4Gb	4Gb	SDP	x16	E	1618	
Samsung	K4A4G085WD-BCPB	4Gb	4Gb	SDP	x8	D	1618	

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Samsung	K4A4G165WD-BCPB	4Gb	4Gb	SDP	x16	D	1618	
Samsung	K4A4G085WE-BCPB	4Gb	4Gb	SDP	x8	E	1618	
Samsung	K4A8G165WB-BCRC	8Gb	8Gb	SDP	x16	B	1628	
Samsung	K4A8G085WB-BCRC	8Gb	8Gb	SDP	x8	B	1622	
Samsung	K4A8G085WC-BCRC	8Gb	8Gb	SDP	x8	C	1619	
Samsung	K4A8G085WC-BCPB	8Gb	8Gb	SDP	x8	C	1619	
Samsung	K4A8G165WC-BCRC	8Gb	8Gb	SDP	x16	C	1616	
Samsung	K4A8G165WC-BCPB	8Gb	8Gb	SDP	x16	C	1616	
Samsung	K4A8G085WB-BCPB	8Gb	8Gb	SDP	x8	B	1618	
Samsung	K4A8G165WB-BCPB	8Gb	8Gb	SDP	x16	B	1618	
Samsung	K4AAG165WB-MCRC	16Gb	8Gb	DDP	x16	B	1601	

**Note: 1. MRC revision 1.3.0 or later is required.**

**Note: 2. MRC revision 1.8.0.2 or later is required.**

**Note: 3. MRC revision 2.1.0 or later is required.**

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### **Approved test labs**

The following test labs have the capability of performing DDR4 Non-ECC SoDIMM system-level testing. For further information, please contact:

### **Advanced Validation Labs**

Attn: Rhonda Duda, Program Manager  
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